NCV8503 Series

Micropower 400 mA LDO Linear Regulators with ENABLE, DELAY, Adjustable $\overline{\text{RESET}}$, and General Use Comparator

The NCV8503 is a family of precision micropower voltage regulators. Their output current capability is 400 mA. The family has output voltage options for Adjustable, 2.5 V, 3.3 V and 5.0 V.

The output voltage is accurate within ± 2.0% with a maximum dropout voltage of 0.6 V at 400 mA. Low quiescent current is a feature drawing less than 1.0 μA with ENABLE = 0 V. With ENABLE = 5.0 V, the part only draws 200 μA with 100 μA load. This part is ideal for any and all battery operated microprocessor equipment.

Microprocessor control logic includes an active $\overline{\text{RESET}}$ (with DELAY).

The active $\overline{\text{RESET}}$ circuit operates correctly at an output voltage as low as 1.0 V. The $\overline{\text{RESET}}$ function is activated during the power up sequence or during normal operation if the output voltage drops below the regulation limits.

The reset threshold voltage can be decreased by the connection of external resistor divider to R_{ADJ} lead.

The general use comparator ($\overline{\text{FLAG}}$/Monitor) is referenced to a temperature stable voltage and provides 1.0 mA of drive current at its open collector output.

The regulator is protected against reverse battery, short circuit, and thermal overload conditions. The device can withstand load dump transients making it suitable for use in automotive environments. The device has also been optimized for EMC conditions.

Features

- Output Voltage Options: Adjustable, 2.5 V, 3.3 V, 5.0 V
- ± 2.0% Output
- Low < 1.0 μA Sleep Current
- Low 200 μA Quiescent Current
- Fixed or Adjustable Output Voltage
- Active $\overline{\text{RESET}}$
- Adjustable Reset
- ENABLE
- 400 mA Output Current Capability
- Fault Protection
  - +60 V Peak Transient Voltage
  - −15 V Reverse Voltage
  - Short Circuit
  - Thermal Overload
- General Use Comparator
- NCV Prefix for Automotive and Other Applications Requiring Site and Change Control
- AEC Qualified
- PPAP Capable
- These are Pb−Free Devices

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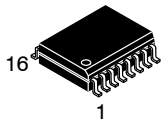
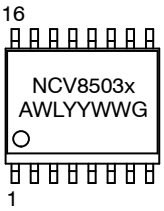


SOIC 16 LEAD
WIDE BODY
EXPOSED PAD
PDW SUFFIX
CASE 751AG

MARKING DIAGRAM



x = Voltage Ratings as Indicated Below:
- A = Adjustable
- 2 = 2.5 V
- 3 = 3.3 V
- 5 = 5.0 V

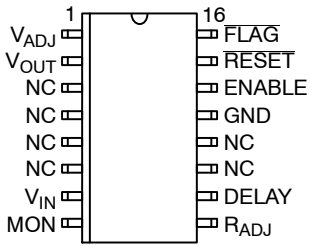
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb−Free Device

ORDERING INFORMATION

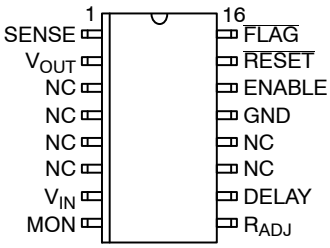
See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.

PIN CONNECTIONS

ADJUSTABLE OUTPUT



FIXED OUTPUT



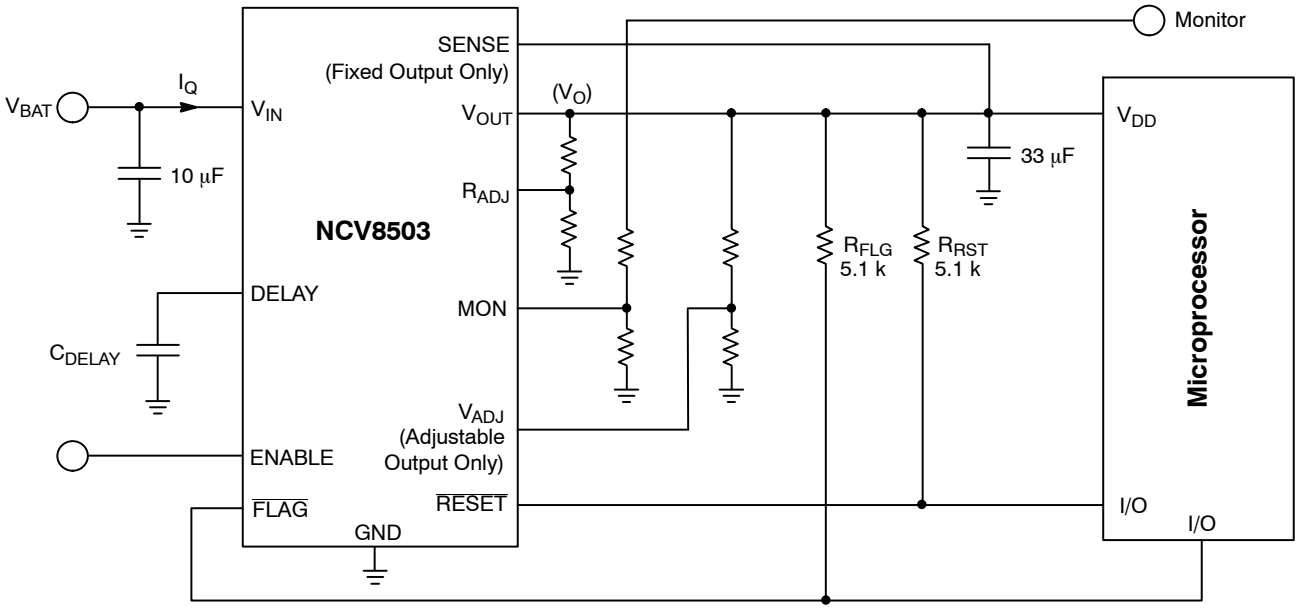


Figure 1. Application Diagram

MAXIMUM RATINGS*†

Rating		Value	Unit
V_{IN} (DC)		−15 to 45	V
Peak Transient Voltage (46 V Load Dump @ V_{IN} = 14 V)		60	V
Operating Voltage		45	V
V_{OUT} (DC)		−0.3 to 16	V
Voltage Range ($\overline{RESET}$, $\overline{FLAG}$, R_{ADJ}, DELAY)		−0.3 to 10	V
Input Voltage Range:	MON V_{ADJ}	−0.3 to 10 −0.3 to 16	V V
Input Voltage Range (ENABLE)		−0.3 to 10**	V
ESD Susceptibility	(Human Body Model) (Machine Model)	4.0 200	kV V
Junction Temperature, T_J		−40 to +150	°C
Storage Temperature, T_S		−55 to 150	°C
Package Thermal Resistance, SOW−16 E PAD:	Junction−to−Case, $R_{\theta JC}$ Junction−to−Ambient, $R_{\theta JA}$	16 57	°C/W °C/W
Lead Temperature Soldering:	Reflow: (SMD styles only) (Note 1)	260 peak (Note 2)	°C

1. 150 second maximum above 217°C.
2. −5°C/+0°C allowable conditions.

*The maximum package power dissipation must be observed.

†During the voltage range which exceeds the maximum tested voltage of V_{IN}, operation is assured, but not specified. Wider limits may apply. Thermal dissipation must be observed closely.

**Reference Figure 17 for switched−battery ENABLE application.

ELECTRICAL CHARACTERISTICS (I_{OUT} = 1.0 mA, ENABLE = 5.0 V, −40°C ≤ T_J ≤ 150°C; V_{IN} = dependent on voltage option (Note 3); unless otherwise specified.)

Characteristic	Test Conditions	Min	Typ	Max	Unit
Output Stage					
Output Voltage for 2.5 V Option (V_O)	6.5 V < V_{IN} < 16 V, 1.0 mA ≤ I_{OUT} ≤ 400 mA **4.5 V < V_{IN} < 26 V**, 1.0 mA ≤ I_{OUT} ≤ 400 mA	2.450 2.425	2.5 2.5	2.550 2.575	V V
Output Voltage for 3.3 V Option (V_O)	7.3 V < V_{IN} < 16 V, 1.0 mA ≤ I_{OUT} ≤ 400 mA **4.5 V < V_{IN} < 26 V**, 1.0 mA ≤ I_{OUT} ≤ 400 mA	3.234 3.201	3.3 3.3	3.366 3.399	V V
Output Voltage for 5.0 V Option (V_O)	9.0 V < V_{IN} < 16 V, 1.0 mA ≤ I_{OUT} ≤ 400 mA **6.0 V < V_{IN} < 26 V**, 1.0 mA ≤ I_{OUT} ≤ 400 mA	4.90 4.85	5.0 5.0	5.10 5.15	V V
Output Voltage for Adjustable Option (V_O)	V_{OUT} = V_{ADJ} (Unity Gain) 6.5 V < V_{IN} < 16 V, 1.0 mA < I_{OUT} < 400 mA **4.5 V < V_{IN} < 26 V**, 1.0 mA < I_{OUT} < 400 mA	 1.274 1.261	 1.300 1.300	 1.326 1.339	 V V
Dropout Voltage (V_{IN} − V_{OUT}) (5.0 V and Adj. > 5.0 V Options Only)	I_{OUT} = 400 mA I_{OUT} = 1.0 mA	− −	400 30	600 150	mV mV
Load Regulation	V_{IN} = 14 V, 5.0 mA ≤ I_{OUT} ≤ 400 mA	−30	5.0	30	mV
Line Regulation (2.5 V, 3.3 V, and Adjustable Options)	4.5 V < V_{IN} < 26 V, I_{OUT} = 1.0 mA	−	5.0	25	mV
Line Regulation (5.0 V Option)	6.0 V < V_{IN} < 26 V, I_{OUT} = 1.0 mA	−	5.0	25	mV
Quiescent Current, (I_Q) Active Mode	I_{OUT} = 100 μA, V_{IN} = 12 V, MON = 3.0 V I_{OUT} = 75 mA, V_{IN} = 14 V, MON = 3.0 V I_{OUT} ≤ 400 mA, V_{IN} = 14 V, MON = 3.0 V	− − −	200 2.5 25	350 5.0 45	μA mA mA
Quiescent Current, (I_Q) Sleep Mode	ENABLE = 0 V, V_{IN} = 12 V, −40°C ≤ T_J ≤ 125°C	−	−	1.0	μA
Current Limit	−	425	800	−	mA
Short Circuit Output Current	V_{OUT} = 0 V	100	500	−	mA
Thermal Shutdown	(Guaranteed by Design)	150	180	−	°C

3. Voltage range specified in the Output Stage of the Electrical Characteristics in boldface type.

ELECTRICAL CHARACTERISTICS (continued) (I_{OUT} = 1.0 mA, ENABLE = 5.0 V, −40°C ≤ T_J ≤ 150°C; V_{IN} = dependent on voltage option (Note 4); unless otherwise specified.)

Characteristic	Test Conditions	Min	Typ	Max	Unit
Reset Function ($\overline{\text{RESET}}$)					
$\overline{\text{RESET}}$ Threshold for 2.5 V Option HIGH (V_{RH}) LOW (V_{RL}) Hysteresis	V_{IN} = 4.5 V (Note 5) (Note 6) V_{OUT} Increasing V_{OUT} Decreasing	 2.35 2.30 25	 – – –	 1.0 × V_O – –	 V V mV
$\overline{\text{RESET}}$ Threshold for 3.3 V Option HIGH (V_{RH}) LOW (V_{RL}) Hysteresis	V_{IN} = 4.5 V (Note 5) (Note 6) V_{OUT} Increasing V_{OUT} Decreasing	 3.10 3.00 35	 – – –	 1.0 × V_O – –	 V V mV
$\overline{\text{RESET}}$ Threshold for 5.0 V Option HIGH (V_{RH}) LOW (V_{RL}) Hysteresis	V_{IN} = 6.0 V (Note 6) V_{OUT} Increasing V_{OUT} Decreasing	 4.70 4.60 50	 – – –	 1.0 × V_O 4.85 –	 V V mV
$\overline{\text{RESET}}$ Threshold for Adjustable Option HIGH (V_{RH}) LOW (V_{RL}) Hysteresis	V_{IN} = 4.5 V (Note 5) (Note 6) V_{OUT} Increasing V_{OUT} Decreasing	 1.22 1.19 10	 – – –	 1.0 × V_O – –	 V V mV
$\overline{\text{RESET}}$ Output Voltage Low (V_{RLO})	V_{IN} = Minimum (Note 6) (Note 7) 1.0 V ≤ V_{OUT} ≤ V_{RL}, $R_{\overline{\text{RESET}}}$ = 5.1 k	–	0.1	0.4	V
DELAY Switching Threshold (V_{DT}) (2.5 V, 3.3 V, and 5.0 V Options)	V_{IN} = Minimum (Note 6) (Note 7)	1.4	1.8	2.2	V
DELAY Switching Threshold (V_{DT}) (Adjustable Option)	V_{IN} = Minimum (Note 6) (Note 7)	1.0	1.3	1.6	V
DELAY Low Voltage	V_{IN} = Minimum (Note 6) (Note 7) V_{OUT} < $\overline{\text{RESET}}$ Threshold Low(min)	–	–	0.2	V
DELAY Charge Current	V_{IN} = Minimum (Note 6) (Note 7) DELAY = 1.0 V, V_{OUT} > V_{RH}	2.5	4.0	5.5	μA
DELAY Discharge Current	V_{IN} = Minimum (Note 6) (Note 7) DELAY = 1.0 V, V_{OUT} < V_{RL}	5.0	–	–	mA
Reset Adjust Switching Voltage ($V_{R(ADJ)}$) Hysteresis	V_{IN} = Minimum (Note 6) (Note 7) Increasing and Decreasing	1.16 20	1.25 50	1.34 100	V mV
$\overline{\text{FLAG}}$/Monitor					
Monitor Threshold	V_{IN} = Minimum (Note 6) (Note 7) Increasing and Decreasing	1.20	1.28	1.36	V
Hysteresis	V_{IN} = Minimum (Note 6) (Note 7)	10	35	75	mV
Input Current	MON = 2.0 V	−0.5	0.1	0.5	μA
Output Saturation Voltage	MON = 0 V, I_{FLAG} = 1.0 mA, V_{IN} = Minimum (Note 6) (Note 7)	–	0.1	0.4	V
Voltage Adjust (Adjustable Output only)					
Input Current	V_{ADJ} = 1.25 V, V_{IN} = Minimum (Note 6) (Note 7)	−0.5	–	0.5	μA
ENABLE					
Input Threshold	Low, V_{IN} = 14 V (Note 6) High, V_{IN} = 14 V (Note 6)	– 2.0	– –	1.0 –	V V
Input Current	ENABLE = 5.0 V, V_{IN} = 14 V (Note 6)	–	30	75	μA

4. Voltage range specified in the Output Stage of the Electrical Characteristics in boldface type.
5. For V_{IN} ≤ 4.5 V, a $\overline{\text{RESET}}$ = Low may occur with the output in regulation.
6. Part is guaranteed by design to meet specification over the entire V_{IN} voltage range, but is production tested only at the specified V_{IN} voltage.
7. Minimum V_{IN} = 4.5 V for 2.5 V, 3.3 V, and Adjustable options. Minimum V_{IN} = 6.0 V for 5.0 V option.

PACKAGE PIN DESCRIPTION, ADJUSTABLE OUTPUT

Pin Number	Pin Symbol	Function
1	V_{ADJ}	Voltage Adjust. A resistor divider from V_{OUT} to this lead sets the output voltage.
2	V_{OUT}	±2.0%, 400 mA output.
3–6, 11, 12	NC	No connection.
7	V_{IN}	Input Voltage.
8	MON	Monitor. Input to comparator. If not needed connect to V_{OUT}.
9	R_{ADJ}	Reset adjust. If not needed connect to ground.
10	DELAY	Timing capacitor for $\overline{\text{RESET}}$ function.
13	GND	Ground. All GND leads must be connected to Ground.
14	ENABLE	ENABLE control for the IC. A high powers the device up.
15	$\overline{\text{RESET}}$	Active reset (accurate to $V_{OUT} \geq 1.0$ V)
16	$\overline{\text{FLAG}}$	Open collector output from comparator.

NOTE: Tentative pinout for SOW−16 E Pad.

PACKAGE PIN DESCRIPTION, FIXED OUTPUT

Pin Number	Pin Symbol	Function
1	SENSE	Kelvin connection which allows remote sensing of output voltage for improved regulation. If remote sensing is not desired, connect to V_{OUT}.
2	V_{OUT}	±2.0%, 400 mA output.
3–6, 11, 12	NC	No connection.
7	V_{IN}	Input Voltage.
8	MON	Monitor. Input to comparator. If not needed connect to V_{OUT}.
9	R_{ADJ}	Reset adjust. If not needed connect to ground.
10	DELAY	Timing capacitor for $\overline{\text{RESET}}$ function.
13	GND	Ground. All GND leads must be connected to Ground.
14	ENABLE	ENABLE control for the IC. A high powers the device up.
15	$\overline{\text{RESET}}$	Active reset (accurate to $V_{OUT} \geq 1.0$ V)
16	$\overline{\text{FLAG}}$	Open collector output from comparator.

NOTE: Tentative pinout for SOW−16 E Pad.

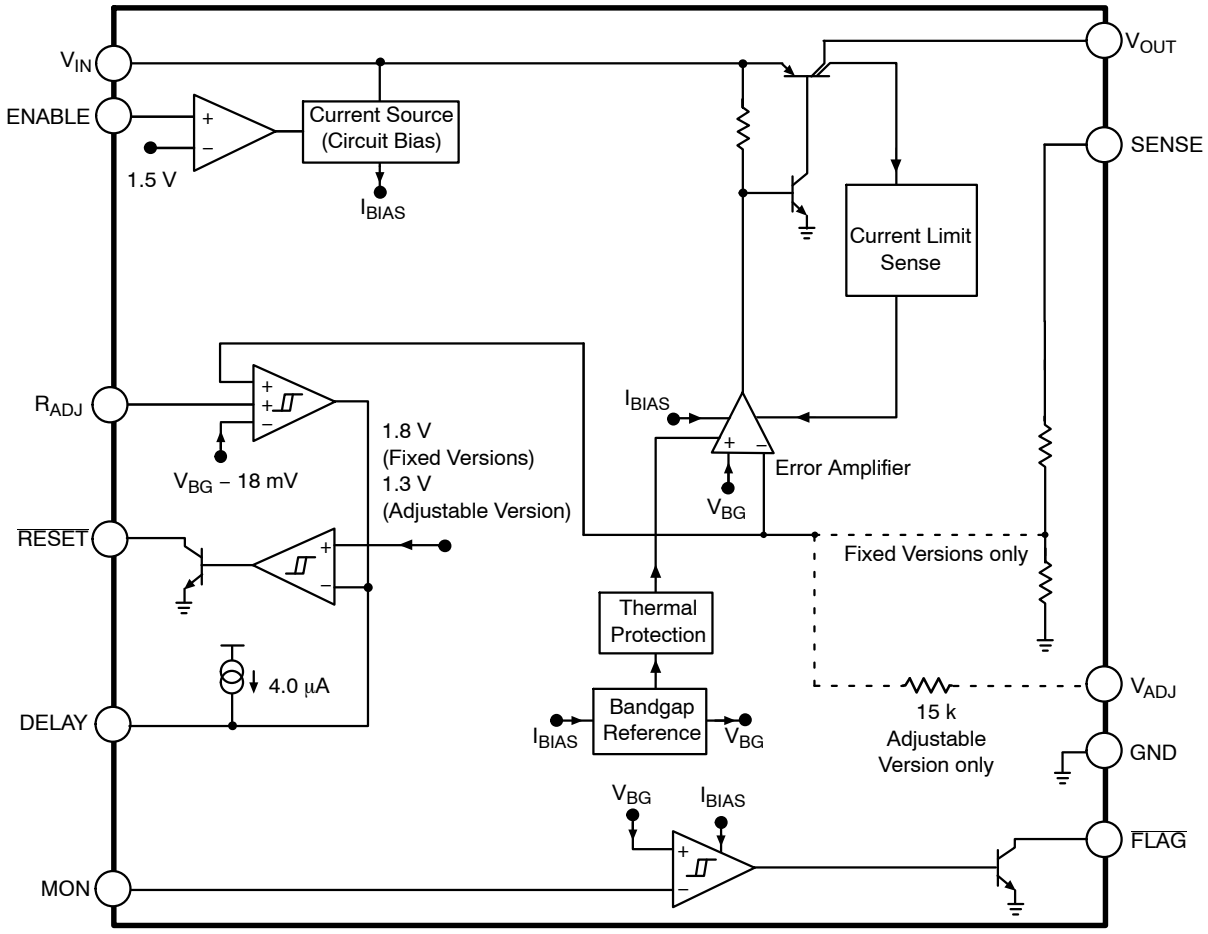


Figure 2. Block Diagram

TYPICAL PERFORMANCE CHARACTERISTICS

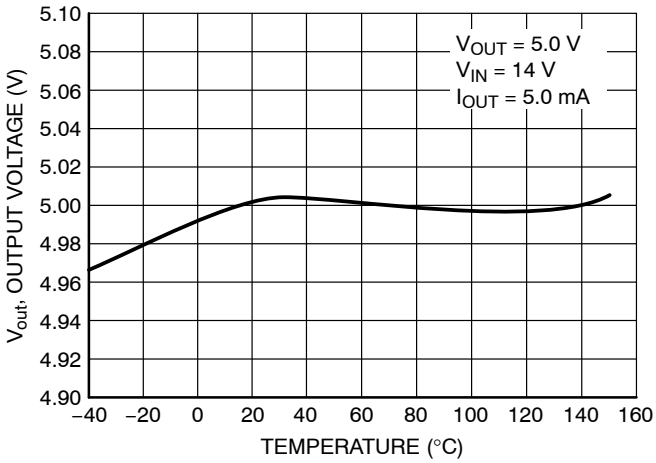


Figure 3. 5 V Output Voltage vs. Temperature

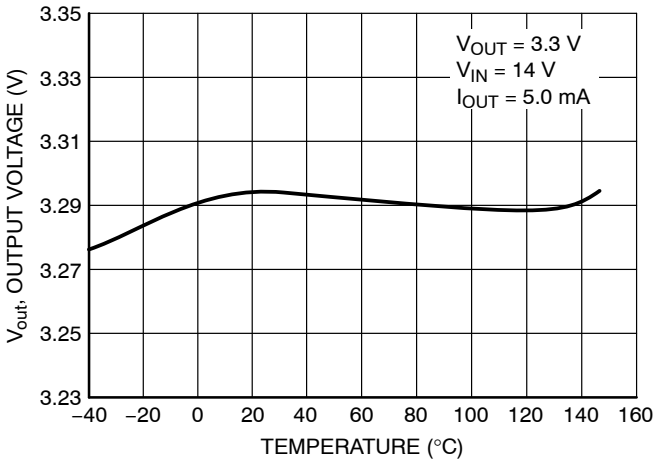


Figure 4. 3.3 V Output Voltage vs. Temperature

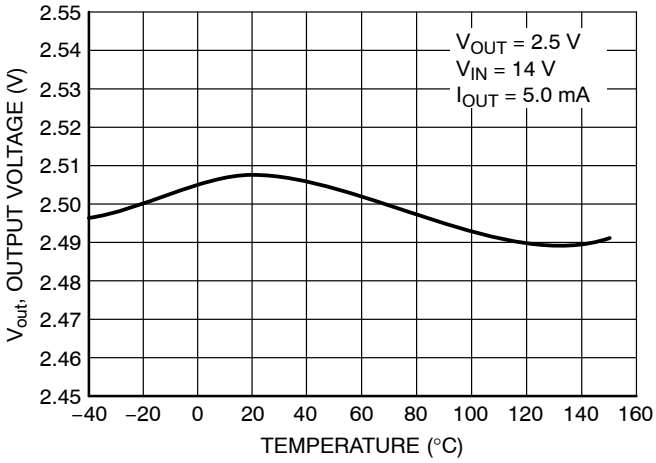


Figure 5. 2.5 V Output Voltage vs. Temperature

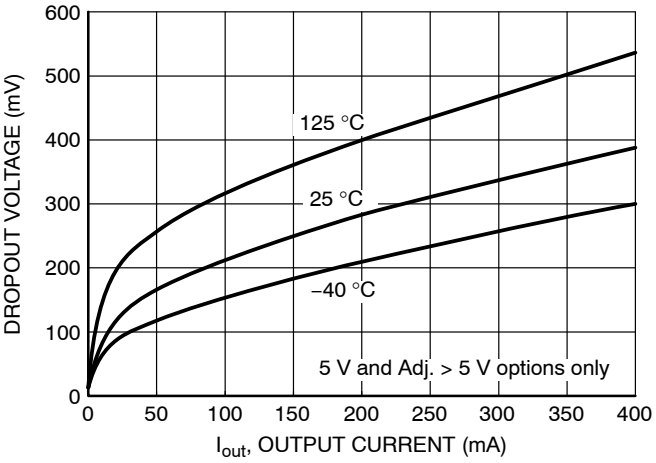


Figure 6. Dropout Voltage vs. Output Current

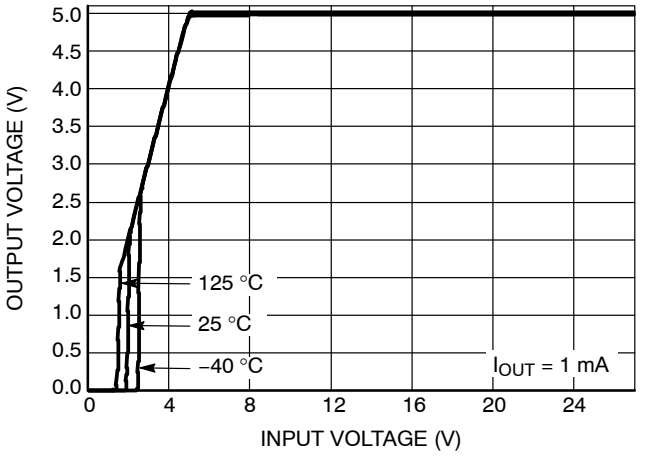


Figure 7. Output Voltage vs. Input Voltage

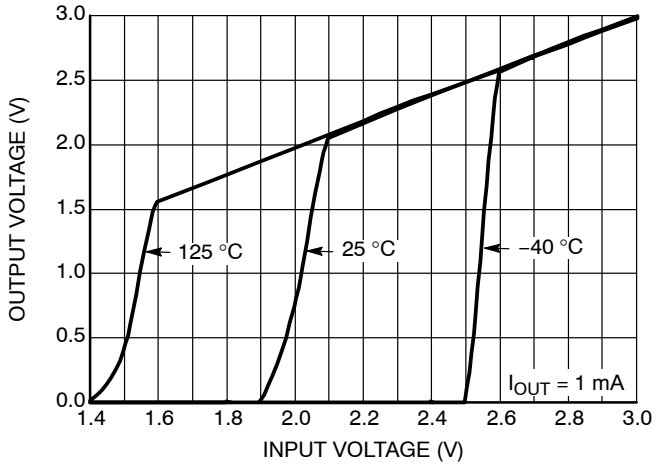


Figure 8. Output Voltage vs. Input Voltage

TYPICAL PERFORMANCE CHARACTERISTICS

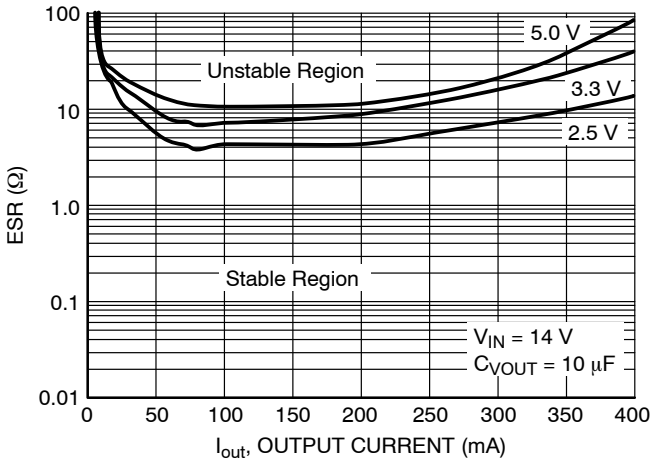


Figure 9. Output Stability with Output Voltage Change

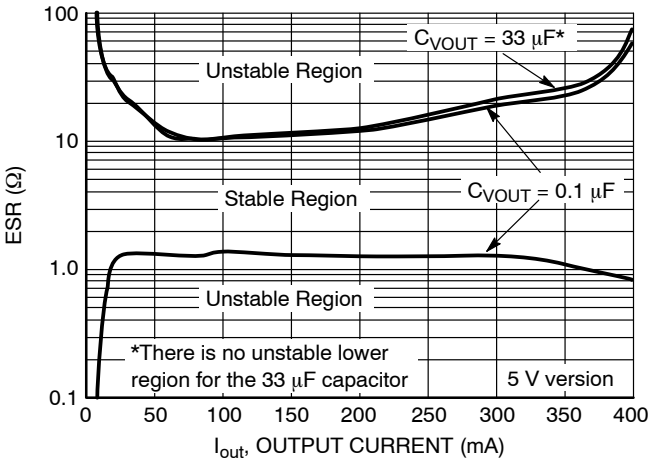


Figure 10. Output Stability with Output Capacitor Change

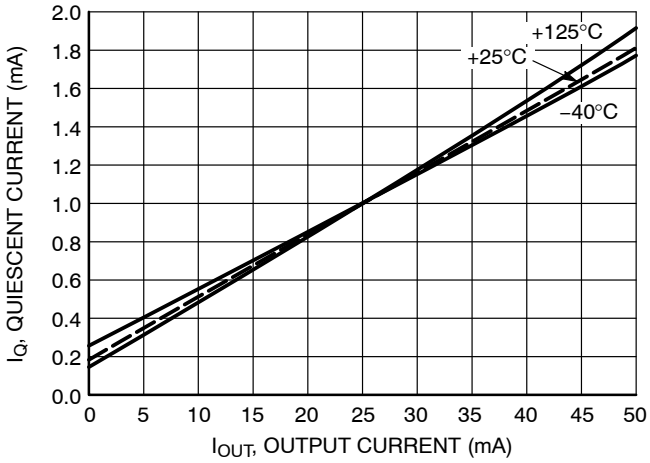


Figure 11. Quiescent Current vs. Output Current

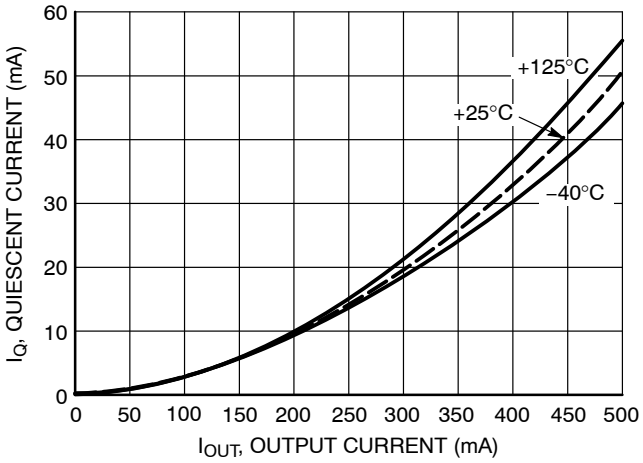


Figure 12. Quiescent Current vs. Output Current

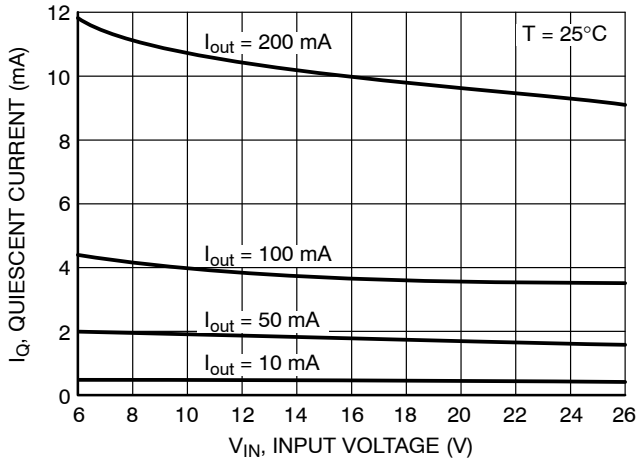


Figure 13. Quiescent Current vs. Input Voltage

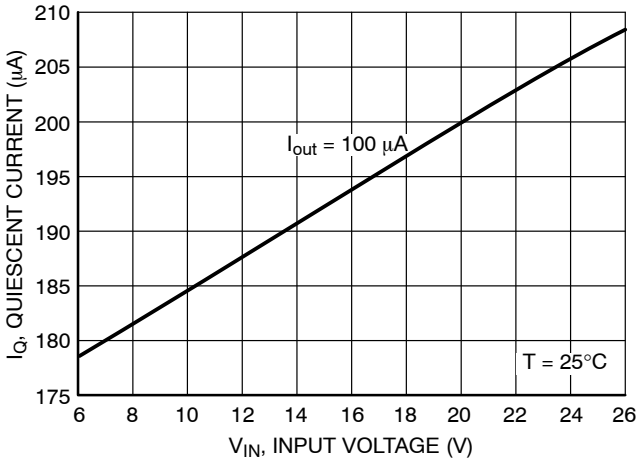


Figure 14. Quiescent Current vs. Input Voltage

CIRCUIT DESCRIPTION

REGULATOR CONTROL FUNCTIONS

The NCV8503 contains the microprocessor compatible control function $\overline{\text{RESET}}$ (Figure 15).

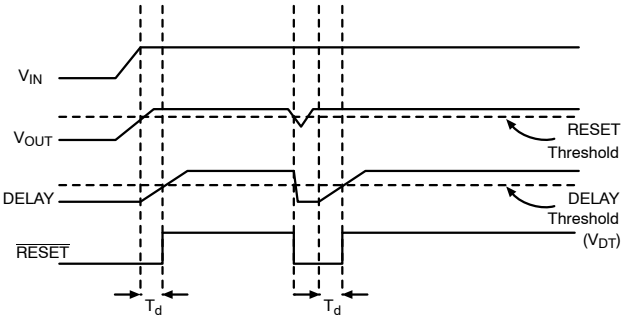


Figure 15. Reset and Delay Circuit Wave Forms

$\overline{\text{RESET}}$ Function

A $\overline{\text{RESET}}$ signal (low voltage) is generated as the IC powers up until V_{OUT} is within 1.5% of the regulated output voltage, or when V_{OUT} drops out of regulation,and is lower than 4.0% below the regulated output voltage. Hysteresis is included in the function to minimize oscillations.

The $\overline{\text{RESET}}$ output is an open collector NPN transistor, controlled by a low voltage detection circuit. The circuit is functionally independent of the rest of the IC thereby guaranteeing that the $\overline{\text{RESET}}$ signal is valid for V_{OUT} as low as 1.0 V.

Adjustable Reset Function

The reset threshold can be made lower by connecting an external resistor divider to the R_{ADJ} lead from the V_{OUT} lead, as displayed in Figure 16. This lead is grounded to select the default value of 4.6 V (on the 5.0 V option).

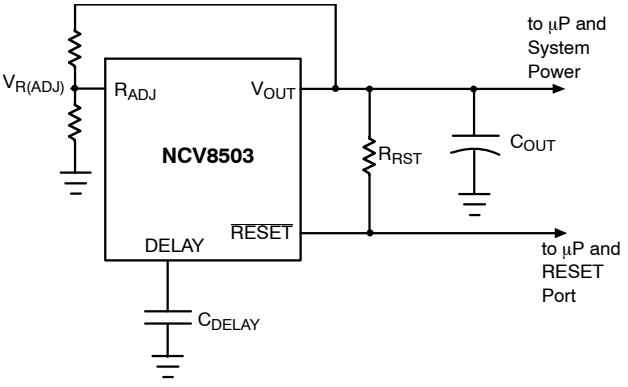


Figure 16. Adjustable $\overline{\text{RESET}}$

ENABLE Function

The part stays in a low I_Q sleep mode when the ENABLE pin is held low. The part has an internal pull down if the pin is left floating.

The integrity of the ENABLE pin allows it to be tied to the battery line through an external resistor. It will withstand load dump potentials in this configuration.

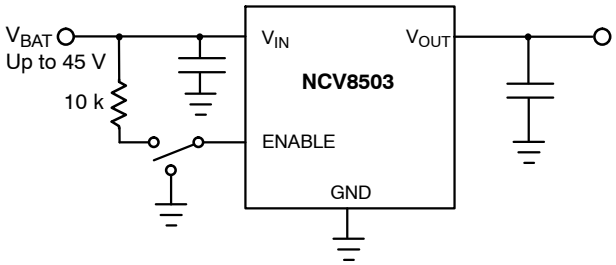


Figure 17. ENABLE Function

DELAY Function

The reset delay circuit provides a programmable (by external capacitor) delay on the $\overline{\text{RESET}}$ output lead.

The DELAY lead provides source current (typically 4.0 μA) to the external DELAY capacitor during the following proceedings:

1. During Power Up (once the regulation threshold has been verified).
2. After a reset event has occurred and the device is back in regulation. The DELAY capacitor is discharged when the regulation ($\overline{\text{RESET}}$ threshold) has been violated. This is a latched incident. The capacitor will fully discharge and wait for the device to regulate before going through the delay time event again.

$\overline{\text{FLAG}}$/Monitor Comparator

A general use comparator is included whose positive input terminal is tied to the on−chip band gap voltage reference. This provides a very temperature stable referenced comparator with versatile uses in any system. The trip point can be programmed externally using a resistor divider to the input monitor (MON) (Figure 18). The typical threshold is 1.28 V on the MON pin.

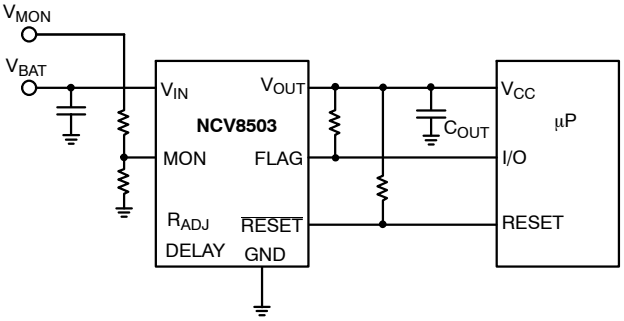


Figure 18. Flag/Monitor Function

Voltage Adjust

Figure 19 shows the device setup for a user configurable output voltage. The feedback to the V_{ADJ} pin is taken from a voltage divider referenced to the output voltage. The loop is balanced around the Unity Gain threshold (1.30 V typical). JEDEC standard JESD78 requires −100 mA trigger test conditions. V_{ADJ} conforms to −75 mA test conditions.

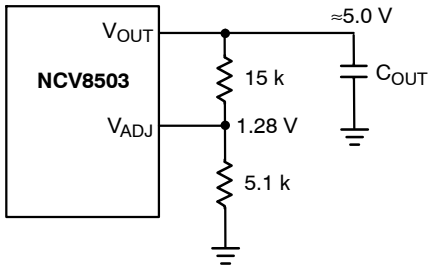


Figure 19. Adjustable Output Voltage

APPLICATION NOTES

FLAG MONITOR

Figure 20 shows the FLAG Monitor waveforms as a result of the circuit depicted in Figure 18. As the input voltage falls (V_{MON}), the Monitor threshold is crossed. This causes the voltage on the $\overline{FLAG}$ output to go low.

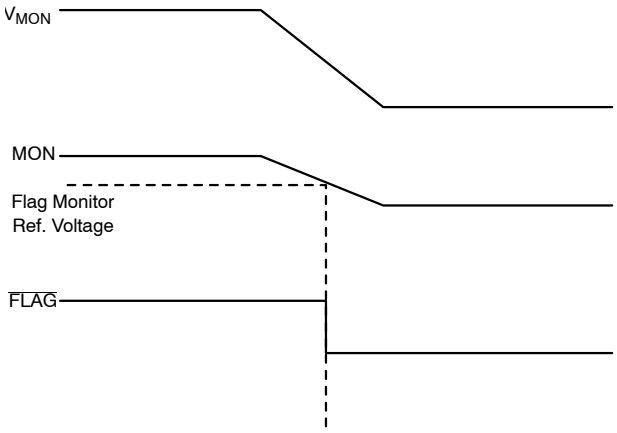


Figure 20. FLAG Monitor Circuit Waveform

SETTING THE DELAY TIME

The delay time is controlled by the Reset Delay Low Voltage, Delay Switching Threshold, and the Delay Charge Current. The delay follows the equation:

$$t_{DELAY} = \frac{[C_{DELAY}(V_{dt} - \text{Reset Delay Low Voltage})]}{\text{Delay Charge Current}}$$

Example:

Using C_{DELAY} = 33 nF.

Assume reset Delay Low Voltage = 0.

Use the typical value for V_{dt} = 1.8 V (2.5 V, 3.3 V, and 5.0 V options).

Use the typical value for Delay Charge Current = 4.2 μA.

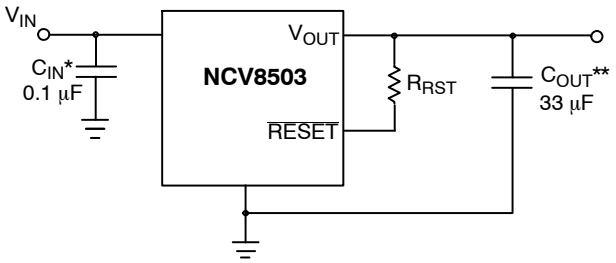
$$t_{DELAY} = \frac{[33\ nF(1.8 - 0)]}{4.2\ \mu A} = 14\ ms$$

STABILITY CONSIDERATIONS

The output or compensation capacitor helps determine three main characteristics of a linear regulator: start−up delay, load transient response and loop stability.

The capacitor value and type should be based on cost, availability, size and temperature constraints. A tantalum or aluminum electrolytic capacitor is best, since a film or ceramic capacitor with almost zero ESR can cause instability. The aluminum electrolytic capacitor is the least expensive solution, but, if the circuit operates at low temperatures (−25°C to −40°C), both the value and ESR of the capacitor will vary considerably. The capacitor manufacturers data sheet usually provides this information.

The value for the output capacitor C_{OUT} shown in Figure 21 should work for most applications, however it is not necessarily the optimized solution.



*C_{IN} required if regulator is located far from the power supply filter
**C_{OUT} required for stability. Capacitor must operate at minimum temperature expected

Figure 21. Test and Application Circuit Showing Output Compensation

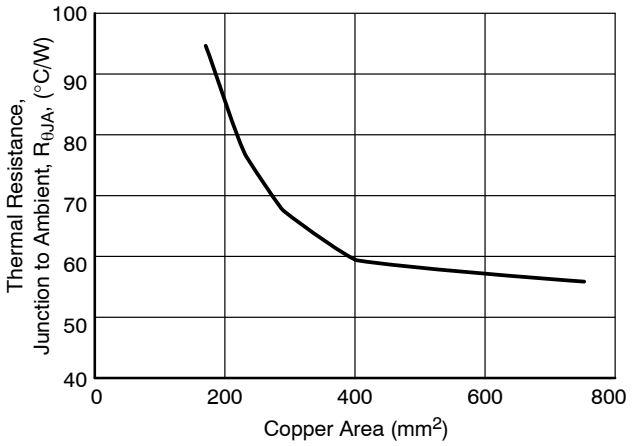


Figure 22. 16 Lead SOW (Exposed Pad), θJA as a Function of the Pad Copper Area (2 oz. Cu Thickness), Board Material = 0.0625″ G−10/R−4

CALCULATING POWER DISSIPATION IN A SINGLE OUTPUT LINEAR REGULATOR

The maximum power dissipation for a single output regulator (Figure 23) is:

$$P_{D(max)} = [V_{IN(max)} - V_{OUT(min)}]I_{OUT(max)} + V_{IN(max)}I_Q \quad (1)$$

where:

$V_{IN(max)}$ is the maximum input voltage,

$V_{OUT(min)}$ is the minimum output voltage,

$I_{OUT(max)}$ is the maximum output current for the application, and

I_Q is the quiescent current the regulator consumes at $I_{OUT(max)}$.

Once the value of $P_{D(max)}$ is known, the maximum permissible value of $R_{\theta JA}$ can be calculated:

$$R_{\theta JA} = \frac{150^oC - T_A}{P_D} \quad (2)$$

The value of $R_{\theta JA}$ can then be compared with those in the package section of the data sheet. Those packages with $R_{\theta JA}$'s less than the calculated value in equation 2 will keep the die temperature below 150°C.

In some cases, none of the packages will be sufficient to dissipate the heat generated by the IC, and an external heatsink will be required.

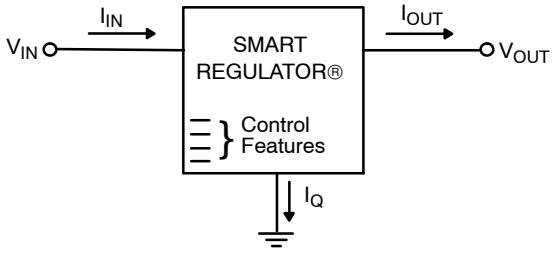


Figure 23. Single Output Regulator with Key Performance Parameters Labeled

HEAT SINKS

A heat sink effectively increases the surface area of the package to improve the flow of heat away from the IC and into the surrounding air.

Each material in the heat flow path between the IC and the outside environment will have a thermal resistance. Like series electrical resistances, these resistances are summed to determine the value of $R_{\theta JA}$:

$$R_{\theta JA} = R_{\theta JC} + R_{\theta CS} + R_{\theta SA} \quad (3)$$

where:

$R_{\theta JC}$ = the junction−to−case thermal resistance,

$R_{\theta CS}$ = the case−to−heatsink thermal resistance, and

$R_{\theta SA}$ = the heatsink−to−ambient thermal resistance.

$R_{\theta JC}$ appears in the package section of the data sheet. Like $R_{\theta JA}$, it too is a function of package type. $R_{\theta CS}$ and $R_{\theta SA}$ are functions of the package type, heatsink and the interface between them. These values appear in heat sink data sheets of heat sink manufacturers.

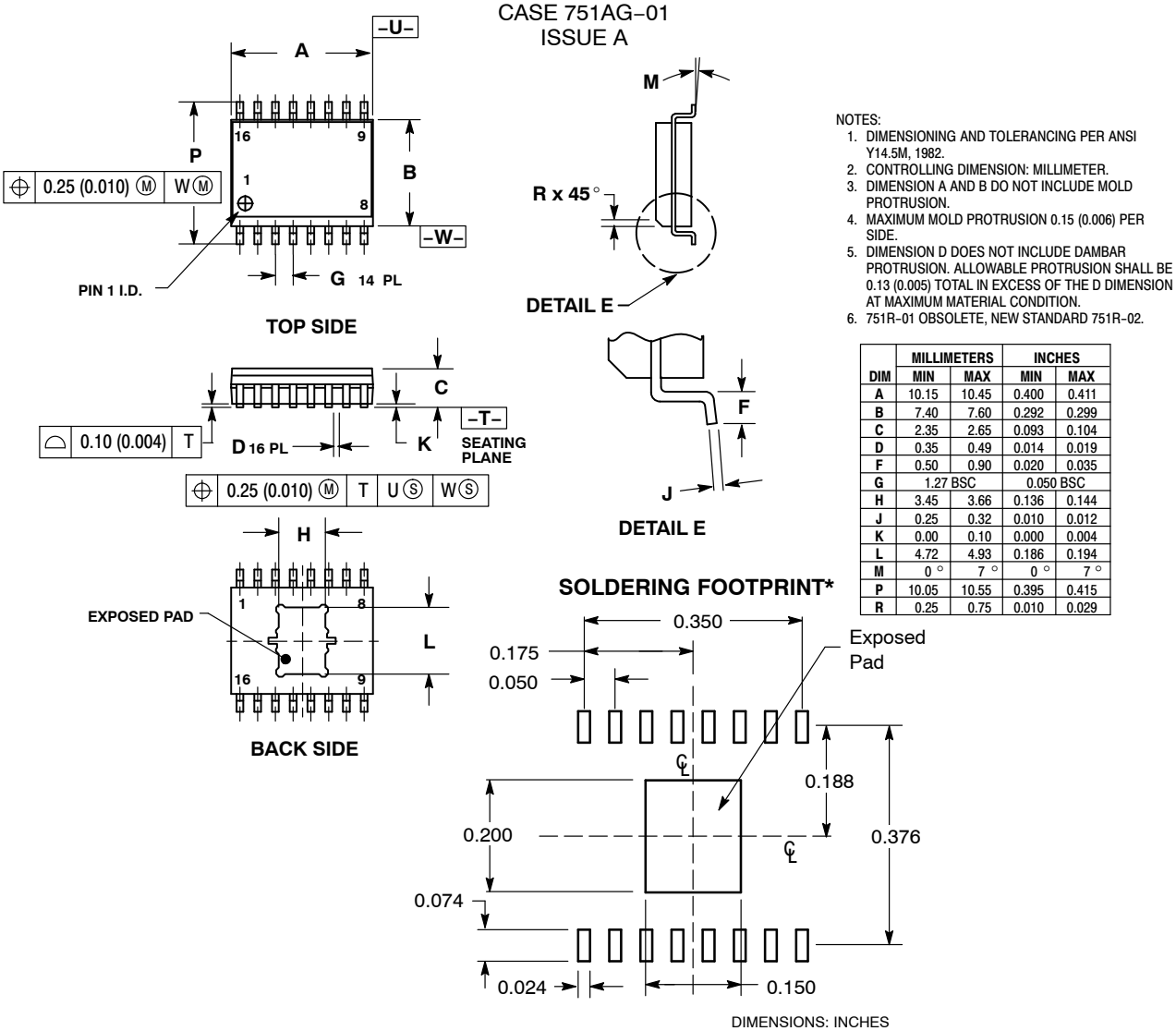
ORDERING INFORMATION

Device	Output Voltage	Package	Shipping†
NCV8503PWADJG	Adjustable	SOW−16 Exposed Pad (Pb−Free)	47 Units/Rail
NCV8503PWADJR2G		SOW−16 Exposed Pad (Pb−Free)	1000 Tape & Reel
NCV8503PW25G	2.5 V	SOW−16 Exposed Pad (Pb−Free)	47 Units/Rail
NCV8503PW25R2G		SOW−16 Exposed Pad (Pb−Free)	1000 Tape & Reel
NCV8503PW33G	3.3 V	SOW−16 Exposed Pad (Pb−Free)	47 Units/Rail
NCV8503PW33R2G		SOW−16 Exposed Pad (Pb−Free)	1000 Tape & Reel
NCV8503PW50G	5.0 V	SOW−16 Exposed Pad (Pb−Free)	47 Units/Rail
NCV8503PW50R2G		SOW−16 Exposed Pad (Pb−Free)	1000 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

SOIC 16 LEAD WIDE BODY
EXPOSED PAD
PDW SUFFIX
CASE 751AG−01
ISSUE A



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751R−01 OBSOLETE, NEW STANDARD 751R−02.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	10.15	10.45	0.400	0.411
B	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC		0.050 BSC	
H	3.45	3.66	0.136	0.144
J	0.25	0.32	0.010	0.012
K	0.00	0.10	0.000	0.004
L	4.72	4.93	0.186	0.194
M	0 °	7 °	0 °	7 °
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

DIMENSIONS: INCHES

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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